Electronic Patent Application Fee Transmittal								
Application Number:	10581657							
Filing Date:	07-Jun-2007							
Title of Invention:	System And Method To Reduce Metal Series Resistance Of Bumped Chip							
First Named Inventor/Applicant Name:	David N. Okada							
Filer:	Natasha Constantinovna Us/Carrah Malone							
Attorney Docket Number:	GWS-005							
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Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
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Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Post-Allowance-and-Post-Issuance:								
Extension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
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